

L Number	Hits	Search Text	DB	Time stamp
-	1	Transfer adj patterned adj metal adj cold-welding	USPAT; US-PGPUB; IBM_TDB	2004/03/10 18:15
-	2	((("5294870") or ("4769292"))).PN.	USPAT; US-PGPUB; IBM_TDB	2004/03/10 18:18
-	1	("5925259").PN.	USPAT; US-PGPUB; IBM_TDB	2004/03/10 18:19
-	7	("2897066" "3647508" "3716911" "4021279" "5512131" "5725788" "5772905").PN.	USPAT	2004/03/10 18:21
-	11	5925259.URPN.	USPAT	2004/03/10 18:23
-	5	("5641611" "5707745" "5925259" "6013538" "6027630").PN.	USPAT	2004/03/10 18:29
-	6	("5641611" "5707745" "5925259" "5998803" "6013538" "6027630").PN.	USPAT	2004/03/10 18:31
-	5247	(pattern\$3) and substrate and (thin adj film) and (press\$3) and die	USPAT; US-PGPUB; IBM_TDB	2004/03/10 18:38
-	3316	(pattern\$3) same substrate and (thin adj film) and (press\$3) and die	USPAT; US-PGPUB; IBM_TDB	2004/03/10 18:38
-	990	(pattern\$3) same substrate same (thin adj film) and (press\$3) and die	USPAT; US-PGPUB; IBM_TDB	2004/03/10 18:38
-	5	(pattern\$3) same substrate same (thin adj film) and (press\$3) and die and (cold adj weld\$3)	USPAT; US-PGPUB; IBM_TDB	2004/03/10 18:41
-	194	(pattern\$3) same substrate same (thin adj film) same die and (press\$3)	USPAT; US-PGPUB; IBM_TDB	2004/03/10 18:42
-	18	5259926.URPN.	USPAT	2004/03/10 18:47
-	9	("5641611" "5707745" "5925259" "5998803" "6013538" "6027630" "6190940" "6214631" "6504096").PN.	USPAT	2004/03/11 09:38
-	6	("5641611" "5707745" "5925259" "5998803" "6013538" "6027630").PN.	USPAT	2004/03/11 09:42
-	1	6468819.URPN.	USPAT	2004/03/11 09:42
-	5	("5641611" "5707745" "5925259" "6013538" "6027630").PN.	USPAT	2004/03/11 09:43
-	2	6294398.URPN.	USPAT	2004/03/11 09:43
-	434	(pattern\$3) same substrate same (electrode or (thin adj film)) same die and (press\$3)	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:00
-	325	(pattern\$3) same substrate same (electrode or (thin adj film)) same die and (press\$3) and remov\$3	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:01
-	128	(pattern\$3) same substrate same (electrode or (thin adj film)) same die and (press\$3) and remov\$3 same die	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:01
-	85	(pattern\$3) same substrate same (electrode or (thin adj film)) same die and (press\$3 same die) and (remov\$3 same die)	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:43
-	20	5900160.URPN.	USPAT	2004/03/11 10:12

-	35	("Re33581" "2905539" "3497377" "3641354" "3716359" "4011009" "4173075" "4274706" "4325779" "4330175" "4382657" "4477158" "4512848" "4528260" "4582566" "4587213" "4690715" "4728591" "4731155" "4802951" "4818336" "4842633" "4897325" "4999489" "5018829" "5020879" "5032216" "5079600" "5143854" "5202227" "5255273" "5259926" "5294369" "5315436" "5512131").PN.	USPAT	2004/03/11 10:23
-	1	("5512131").PN.	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:33
-	37	(pattern\$3) same substrate same (electrode or (thin adj film)) same stamp\$3 and (remov\$3 same stamp)	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:55
-	596	(die or stamp) and (cold adj weld\$3)	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:56
-	94	((die or stamp) same (cold adj weld\$3)) and substrate	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:56
-	90	((die or stamp) same (cold adj weld\$3)) and substrate and (film or layer)	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:57
-	64	((die or stamp) same (cold adj weld\$3)) and substrate and (film or layer) and remov\$3	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:57
-	50	((die or stamp) same (cold adj weld\$3)) and substrate and (film or layer) and (remov\$3 same (die or stamp))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 10:58
-	228	(die or stamp) same (cold adj weld\$3)	USPAT; US-PGPUB; IBM_TDB	2004/03/11 11:54
-	6	("5772905" "5814885" "5925259" "6027630" "6274508" "6281038").PN.	USPAT	2004/03/11 11:27
-	35	("Re33581" "2905539" "3497377" "3641354" "3716359" "4011009" "4173075" "4274706" "4325779" "4330175" "4382657" "4477158" "4512848" "4528260" "4582566" "4587213" "4690715" "4728591" "4731155" "4802951" "4818336" "4842633" "4897325" "4999489" "5018829" "5020879" "5032216" "5079600" "5143854" "5202227" "5255273" "5259926" "5294369" "5315436" "5512131").PN.	USPAT	2004/03/11 11:48
-	598	(die or stamp or (forming adj member)) and (cold adj weld\$3)	USPAT; US-PGPUB; IBM_TDB	2004/03/11 11:55
-	229	(die or stamp or (forming adj member)) and (cold adj weld\$3) and substrate	USPAT; US-PGPUB; IBM_TDB	2004/03/11 11:55
-	79	(die or stamp or (forming adj member)) and (cold adj weld\$3) and substrate and ((metal or conduct\$3) adj (film or layer))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 11:58
-	6	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion)) and (cold adj weld\$3) and substrate and ((metal or conduct\$3) adj (film or layer))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 12:00
-	6	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion)) and (cold adj weld\$3) and substrate and ((metal or conduct\$3) adj (film or layer))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 12:03

-	6	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion)) and (cold adj weld\$3) and substrate	USPAT; US-PGPUB; IBM_TDB	2004/03/11 12:02
-	20	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion) or indentation) and (cold adj weld\$3) and substrate	USPAT; US-PGPUB; IBM_TDB	2004/03/11 12:02
-	1746	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion) or indentation) and substrate and ((metal or conduct\$3) adj (film or layer))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 12:04
-	711	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion) or indentation) and substrate with ((metal or conduct\$3) adj (film or layer))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 12:04
-	99	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion) or indentation) and substrate with ((metal or conduct\$3) adj (film or layer)) and ((press\$3 or forc@3) with (die or stamp or (forming adj member)))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 12:06
-	9	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion) or indentation) and substrate with ((metal or conduct\$3) adj (film or layer)) and ((press\$3 or forc@3) with (die or stamp or (forming adj member))) and ((releas\$3 or remov@3) with (die or stamp or (forming adj member)))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 12:06
-	1	("5707745").PN.	USPAT; US-PGPUB; IBM_TDB	2004/03/11 16:26
-	130	heterostructure same polymer	USPAT; US-PGPUB; IBM_TDB	2004/03/11 16:26
-	88	heterostructure with polymer	USPAT; US-PGPUB; IBM_TDB	2004/03/11 16:26
-	5	heterostructure near polymer	USPAT; US-PGPUB; IBM_TDB	2004/03/11 16:26
-	3	(29/846,847).ccls. and (die or stamp or (forming adj member)) and (cold adj weld\$3) and substrate	USPAT; US-PGPUB; IBM_TDB	2004/03/11 17:55
-	4	(438/22,23).ccls. and (die or stamp or (forming adj member)) and (cold adj weld\$3) and substrate	USPAT; US-PGPUB; IBM_TDB	2004/03/11 17:55
-	1	(257/79,88).ccls. and (die or stamp or (forming adj member)) and (cold adj weld\$3) and substrate	USPAT; US-PGPUB; IBM_TDB	2004/03/11 17:56
-	112	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion)) and substrate and ((metal or conduct\$3) adj (film or layer))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 17:57
-	61	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion)) and substrate and ((metal or conduct\$3) adj (film or layer)) and (die or stamp or (forming adj member)) with press\$3	USPAT; US-PGPUB; IBM_TDB	2004/03/11 17:59

-	23	((die or stamp or (forming adj member)) with ((rais\$3 or project\$3 or protrud\$3) adj portion)) and substrate and ((metal or conduct\$3) adj (film or layer)) and ((die or stamp or (forming adj member)) with press\$3) and ((die or stamp or (forming adj member)) with (remov\$3 or releas\$3))	USPAT; US-PGPUB; IBM_TDB	2004/03/11 18:00
-	1	("6214631").PN.	USPAT; US-PGPUB; IBM_TDB	2004/06/18 08:29
-	45	(burrows-paul-e).in.	USPAT; US-PGPUB; IBM_TDB	2004/06/21 09:32
-	25	(burrows-paul-e).in. and pattern\$3	USPAT; US-PGPUB; IBM_TDB	2004/06/21 09:33
-	22	(burrows-paul-e).in. and pattern\$3 and metal	USPAT; US-PGPUB; IBM_TDB	2004/06/21 09:33
-	4	(burrows-paul-e).in. and pattern\$3 and metal and die	USPAT; US-PGPUB; IBM_TDB	2004/06/21 09:33